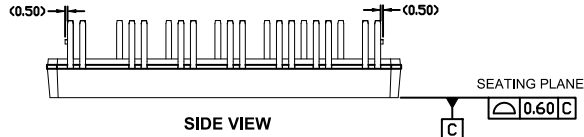


DIP26 67.8x40
CASE 181AD
ISSUE B

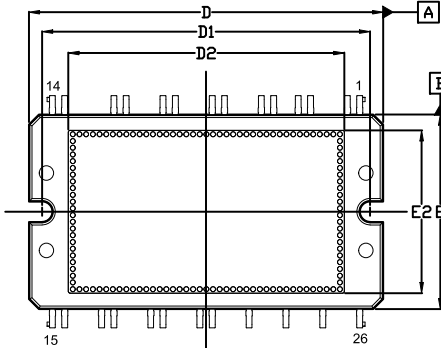
DATE 05 AUG 2021



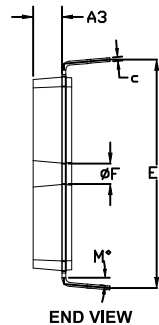
SIDE VIEW

NOTES:

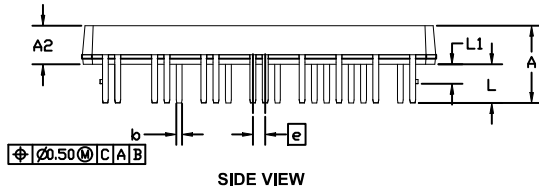
1. Dimensioning and tolerancing as per ASME Y14.5M, 2009
2. Controlling Dimension: Millimeters
3. Dimensions are exclusive of Burrs, Mold Flash, and Tiebar extrusions
4. Dimensions "b" and "c" apply to plated leads
5. Position of the leads is determined at the root of the lead where it exits the package body



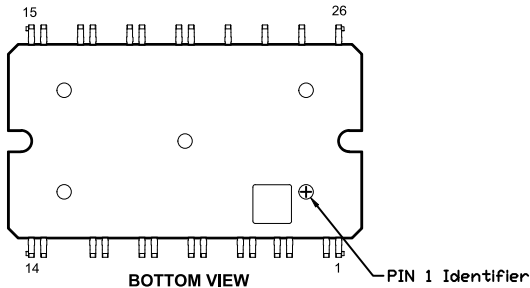
TOP VIEW



END VIEW



SIDE VIEW

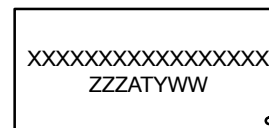


BOTTOM VIEW

PIN 1 Identifier

| DIM | MILLIMETERS | | |
|-----|-------------|-------|-------|
| | MIN | NOM | MAX |
| A | 15.50 | 16.00 | 16.50 |
| A2 | 7.80 | 8.00 | 8.20 |
| A3 | 6.00 REF | | |
| b | 1.10 | 1.20 | 1.30 |
| c | 0.70 | 0.80 | 0.90 |
| D | 72.70 | 73.20 | 73.70 |
| D1 | 67.30 | 67.80 | 68.30 |
| D2 | 57.30 REF | | |
| E | 39.70 | 40.20 | 40.70 |
| E1 | 46.70 | 47.20 | 47.70 |
| E2 | 33.87 REF | | |
| e | 2.54 BSC | | |
| F | 4.00 | 4.20 | 4.40 |
| L | 8.00 REF | | |
| L1 | 3.50 | 4.00 | 4.50 |
| M | 4° | 5° | 6° |

GENERIC MARKING DIAGRAM*



XXX = Specific Device Code
ZZZ = Assembly Lot Code
AT = Assembly & Test Location
Y = Year
WW = Work Week

*This information is generic. Please refer to device data sheet for actual part marking. Pb-Free indicator, "G" or microdot "▪", may or may not be present. Some products may not follow the Generic Marking.

| | | |
|-------------------------|----------------------|--|
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| DESCRIPTION: | DIP26 67.8x40 | PAGE 1 OF 1 |

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